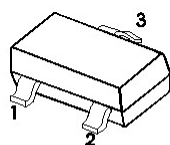


**SOT-23****SOT-23 贴片塑封开关三极管****SOT-23 Plastic-Encapsulate Switching Transistors****特征 Features**

- 最大功率耗散 300mW; Power Dissipation of 300mW
- 高稳定性和可靠性。High Stability and High Reliability

**机械数据 Mechanical Data**

- 封装: SOT-23 封装 SOT-23 Small Outline Plastic Package
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any



1. BASE
2. EMITTER
3. COLLECTOR

**Marking: 2X**

极限值和温度特性(TA = 25°C 除非另有规定)

**Maximum Ratings & Thermal Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

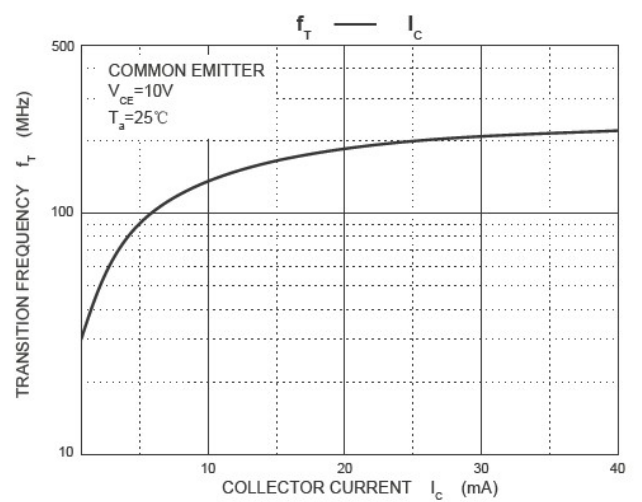
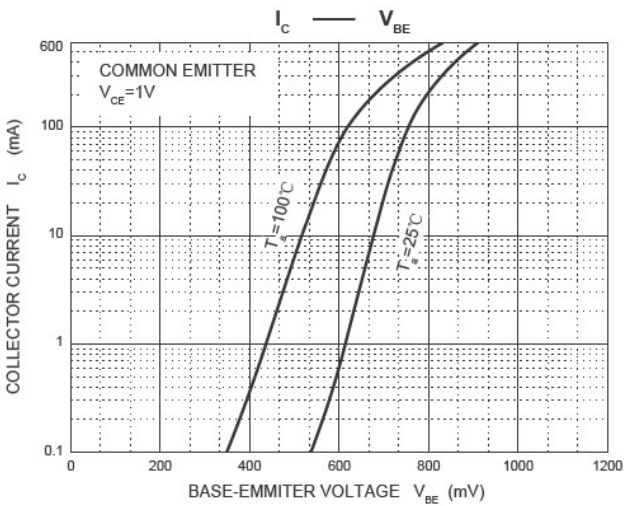
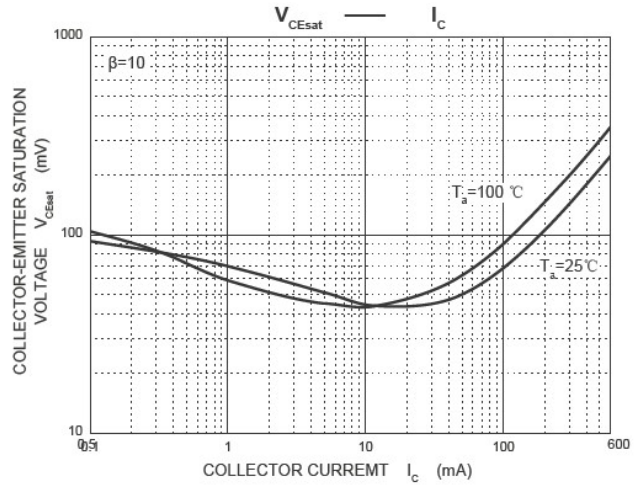
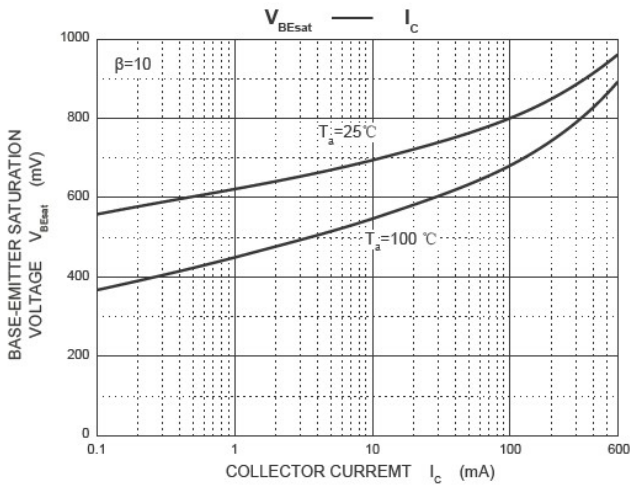
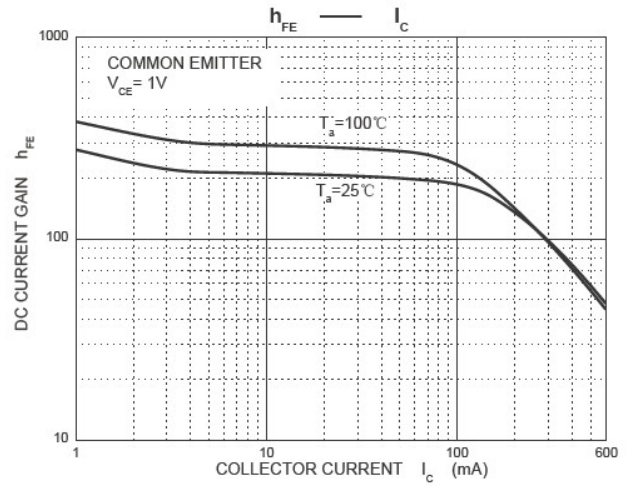
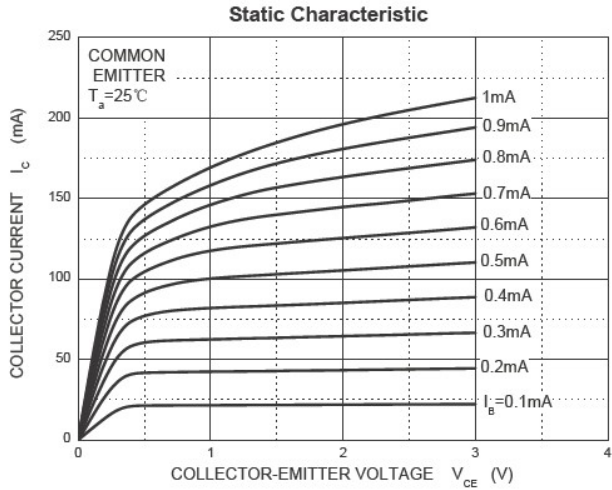
参数 Parameters	符号 Symbol	数值 Value	单位 Unit
Collector-Base Voltage	V <sub>CB0</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter -Base Voltage	V <sub>EBO</sub>	6	V
Collector Current-Continuous	I <sub>C</sub>	600	mA
Collector Power Dissipation	P <sub>C</sub>	300	mW
Junction Temperature	T <sub>j</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55-+150	°C
Thermal resistance From junction to ambient	R <sub>θJA</sub>	417	°C/W

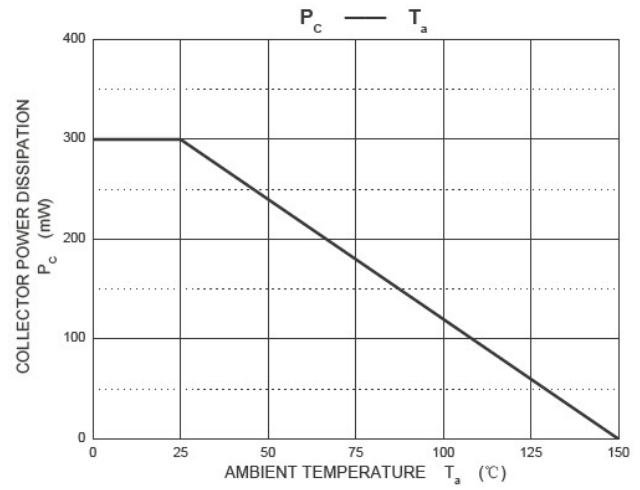
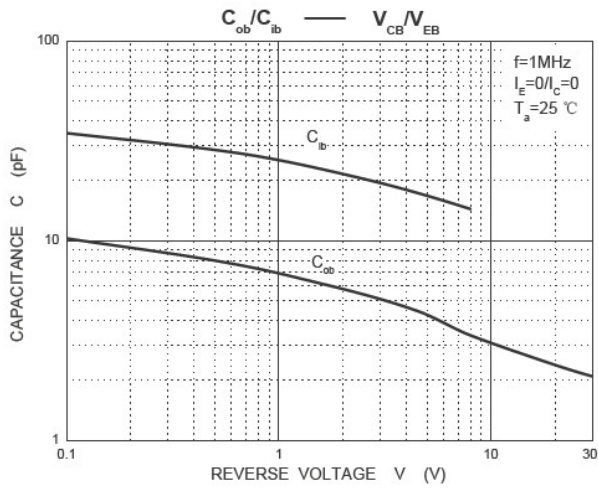
电特性 (TA = 25°C 除非另有规定)

**Electrical Characteristics** (Ratings at 25°C ambient temperature unless otherwise specified.)

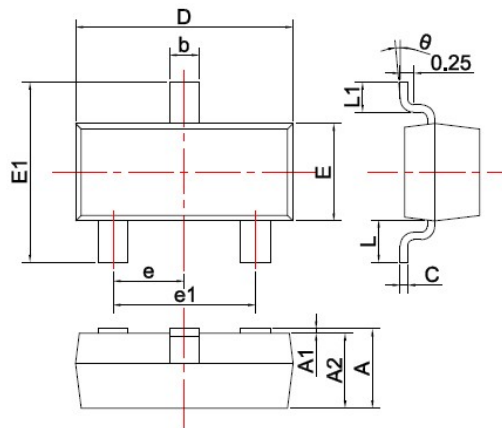
参数 Parameter	符号 Symbols	测试条件 Test Condition	界限 Limits		单位 Unit
			Min	Max	
Collector-base breakdown voltage	V(BR)CBO	I <sub>C</sub> =100uA, I <sub>E</sub> =0	60		V
Collector-emitter breakdown voltage	V(BR)CEO	I <sub>C</sub> =1mA, I <sub>B</sub> =0	40		V
Emitter-base breakdown voltage	V(BR)EBO	I <sub>E</sub> =100uA, I <sub>C</sub> =0	6		V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =50V, I <sub>E</sub> =0		100	nA
Collector cut-off current	I <sub>CEX</sub>	V <sub>CE</sub> =35V, V <sub>EB(off)</sub> =0.4V		100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =5V, I <sub>C</sub> =0		100	nA
DC current gain	hFE(1)	V <sub>CE</sub> =1V, I <sub>C</sub> =0.1mA	20		
	hFE(2)	V <sub>CE</sub> =1V, I <sub>C</sub> =1mA	40		
	hFE(3)	V <sub>CE</sub> =1V, I <sub>C</sub> =10mA	80		
	hFE(4)	V <sub>CE</sub> =1V, I <sub>C</sub> =150mA	100	300	
	hFE(5)	V <sub>CE</sub> =1V, I <sub>C</sub> =500mA	40		
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =150mA, I <sub>B</sub> =15mA		0.40	V
		I <sub>C</sub> =500mA, I <sub>B</sub> =50mA		0.75	V
Base -emitter saturation voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =150mA, I <sub>B</sub> =15mA		0.95	V
		I <sub>C</sub> =500mA, I <sub>B</sub> =50mA		1.20	V
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =20mA, f=100MHz	250		MHz
Delay time	t <sub>d</sub>	V <sub>CC</sub> =30V, V <sub>BE(off)</sub> =-2V,		15	nS
Rise time	t <sub>r</sub>	I <sub>C</sub> =150mA, I <sub>B1</sub> =15mA		20	nS
Storage time	t <sub>s</sub>	V <sub>CC</sub> =30V, I <sub>C</sub> =150mA, I <sub>B1</sub> =I <sub>B2</sub> =15mA		225	nS
Fall time	t <sub>f</sub>			60	nS

Typical characteristics





**SOT-23 PACKAGE OUTLINE** Plastic surface mounted package

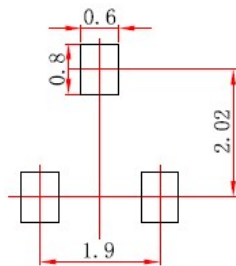


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°

Unit: mm

**焊盘设计参考** Precautions: PCB Design

Recommended land dimensions for SOT-23 diode. Electrode patterns for PCBs



- Note:
1. Controlling dimension: In millimeters.
  2. General tolerance: ± 0.05mm.
  3. The pad layout is for reference purposes only.